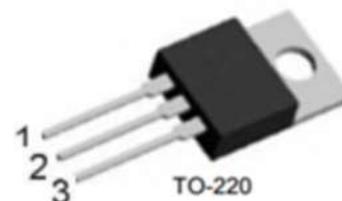


### Features:

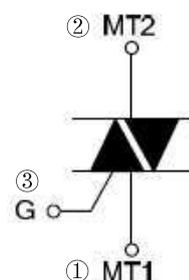
Triacs is fabricated using separation diffusion processes ,the junction termination areas are passivated with glass. Thanks to highly sensitive triggering levels and reliability,the Triacs series is suitable for domestic lighting ,heating and motor speed controllers.



### Applications:

Domestic lighting ,heating and motor speed controllers.

### Symbol



### Ordering Information

Part No.	Package	Packing
BT137-600E	TO-220	50pcs / Tube
BT137-800E	TO-220	50pcs / Tube

### ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	RATINGS	UNIT
Repetitive Peak Off State Voltage	V <sub>DRM</sub>	600	V
		800*	
RMS On-state Current (Full sine wave; T <sub>mb</sub> ≤107°C)	I <sub>T(RMS)</sub>	8	A
Non-Repetitive Peak. On-State Current (Full sine wave; T <sub>j</sub> =25°C prior to surge)	I <sub>TSM</sub>	65	A
		71	
I <sup>2</sup> t For Fusing t=10ms	I <sup>2</sup> t	21	A <sup>2</sup> s
Rate of Rise of On-state Current I <sub>TM</sub> =6A; I <sub>G</sub> =0.2A, dI <sub>G</sub> /dt=0.2A/μs	dI <sub>T</sub> /dt	50	A/μs
		50	
		50	
		10	
Peak Gate Voltage	V <sub>GM</sub>	5	V
Peak Gate Current	I <sub>GM</sub>	2	A
Peak Gate Power	P <sub>GM</sub>	5	W
Average Gate Power (Over any 20ms period)	P <sub>G(AV)</sub>	0.5	W
Operating Junction Temperature	T <sub>j</sub>	125	°C
Storage Temperature	T <sub>stg</sub>	-40~150	°C

\*Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6A/μs.

**THERMAL CHARACTERISTICS**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Thermal Resistance Junction to Mounting Base Full cycle Half cycle	Rth j-mb			2.0 2.4	K/W
Thermal Resistance Junction to Ambient In free air	Rth j-a		60		K/W

**ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$ , unless otherwise stated)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>STATIC CHARACTERISTICS</b>						
Gate Trigger Current	I <sub>GT</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A T2+G+ T2+G- T2-G- T2-G+		2.2 5.5 5.2 32	10 10 10 35	mA
Latching Current	I <sub>L</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A T2+G+ T2+G- T2-G- T2-G+		5.8 13 7 16	25 35 25 35	mA
Holding Current	I <sub>H</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A		5	20	mA
Gate Trigger Voltage	V <sub>GT</sub>	V <sub>D</sub> =12V, I <sub>T</sub> =0.1A; T <sub>J</sub> =25°C V <sub>D</sub> =400V, I <sub>T</sub> =0.1A; T <sub>J</sub> =125°C		0.7 0.25	1.0	V
On-State Voltage	V <sub>T</sub>	I <sub>T</sub> =10A		1.3	1.65	V
Off-state Leakage Current	I <sub>D</sub>	V <sub>D</sub> =600V, T <sub>J</sub> =125°C		0.1	0.5	mA
<b>DYNAMIC CHARACTERISTICS</b>						
Critical Rate of Rise of off-state Voltage	dV <sub>D</sub> /dt	V <sub>DM</sub> =67% V <sub>DRM(max)</sub> , T <sub>J</sub> =125°C Exponential waveform, Gate open circuit	100	250		V/μs
Gate Controlled Turn-on Time	t <sub>gt</sub>	I <sub>TM</sub> =12A, V <sub>D</sub> =V <sub>DRM</sub> , I <sub>G</sub> =0.1A dI <sub>G</sub> /dt=5A/μs		2		μs

**TYPICAL CHARACTERISTICS**

Figure 1. Maximum on-state Dissipation. Plot vs RMS On-state Current,  $I_T(RMS)$ , Where  $\alpha$  = conduction Angle.

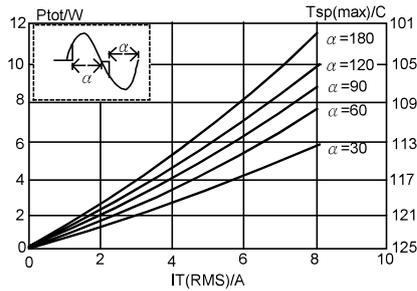


Figure 4. Maximum Permissible RMS Current  $I_T(RMS)$  vs mounting base Temperature  $T_{mb}$

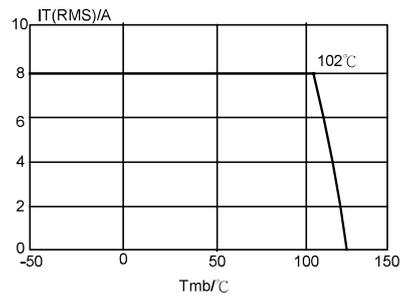


Figure 2. Maximum Permissible Non-repetitive Peak On-state Current  $I_{TSM}$ , vs Pulse Width  $t_p$ , for Sinusoidal Currents,  $t_p \approx 20ms$

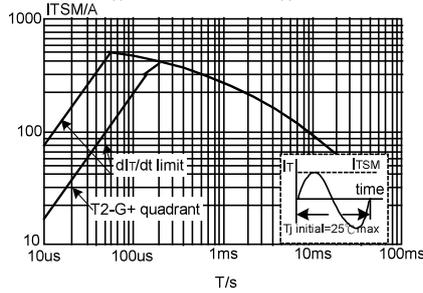


Figure 5. Maximum Permissible Repetitive RMS on-state Current  $I_T(RMS)$  vs Surge Duration, for Sinusoidal Currents,  $f=50Hz$ ;  $T_{mb} \approx 102^\circ C$

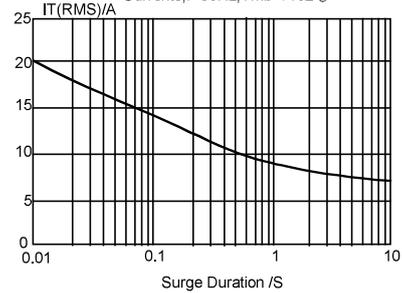


Figure 3. Maximum Permissible Non-Repetitive peak on-state Current  $I_{TSM}$ , vs Number of Cycles, for Sinusoidal Currents,  $f=50Hz$

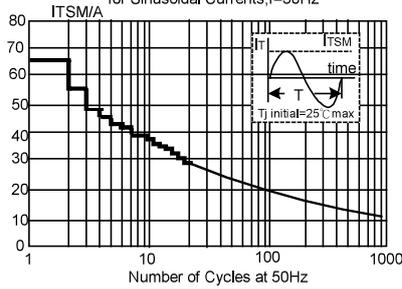
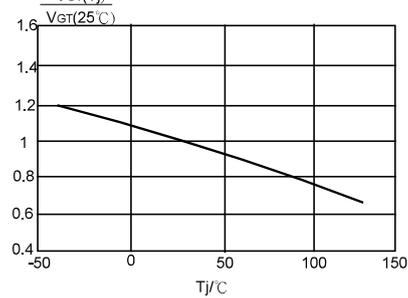


Figure 6. Normalised Gate Trigger Voltage  $V_{GT}(T_J) / V_{GT}(25^\circ C)$ , vs Junction Temperature  $T_J$



**TYPICAL CHARACTERISTICS**

Figure 7. Normalised Gate Trigger Current  $I_{GT}(T_j)/I_{GT}(25^\circ\text{C})$ , vs Junction Temperature  $T_j$

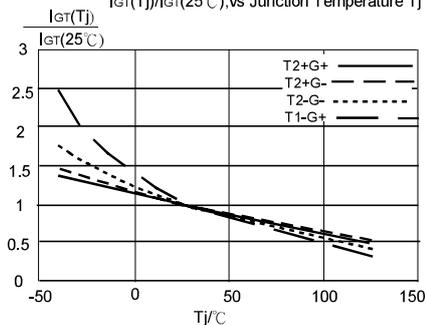


Figure 10. Typical and Maximum On-state Characteristic

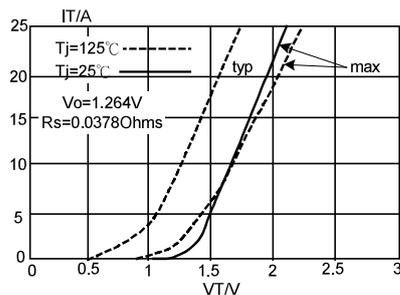


Figure 8. Normalised Latching Current  $I_L(T_j)/I_L(25^\circ\text{C})$ , vs Junction Temperature  $T_j$

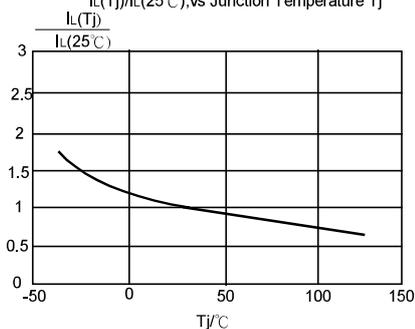


Figure 11. Transient Thermal Impedance  $Z_{th\ j-mb}$ , vs Pulse Width  $t_p$

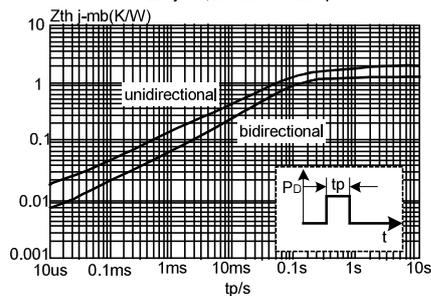


Figure 9. Normalised Holding Current  $I_H(T_j)/I_H(25^\circ\text{C})$ , vs Junction Temperature  $T_j$

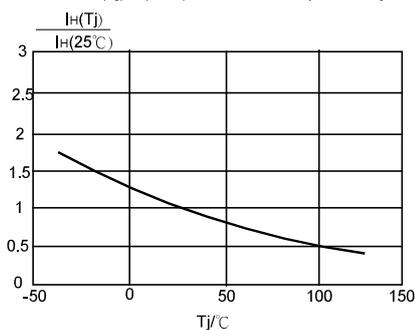
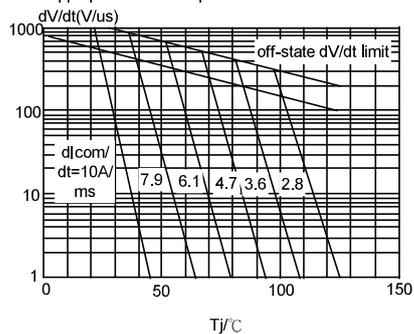


Figure 12. Typical commutation  $dV/dt$  vs junction temperature, parameter commutation  $dI/dt$ . The triac should commutate when the  $dV/dt$  is below the value on the appropriate curve for pre-commutation  $dI/dt$



**TO-220 Mechanical Drawing**

